

# SPP2341

## DESCRIPTION

The SPP2341 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

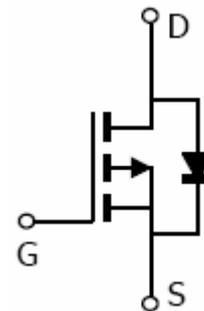
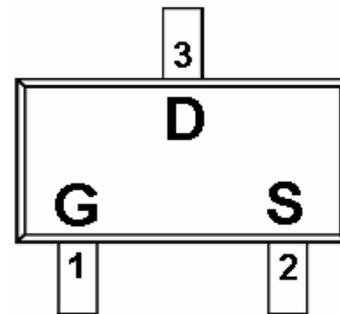
## FEATURES

- ◆ -20V/-3.3 A,  $R_{DS(ON)} = 45m\Omega @ V_{GS} = -4.5V$
- ◆ -20V/-2.8 A,  $R_{DS(ON)} = 55m\Omega @ V_{GS} = -2.5V$
- ◆ -20V/-2.3 A,  $R_{DS(ON)} = 65m\Omega @ V_{GS} = -1.8V$
- ◆ Super high density cell design for extremely low  $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23-3L package design

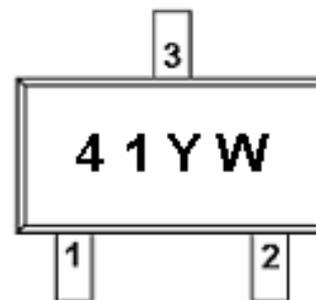
## APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

## PIN CONFIGURATION(SOT-23-3L)



## PART MARKING



Y : Year Code  
W : Week Code

# SPP2341

## PIN DESCRIPTION

| Pin | Symbol | Description |
|-----|--------|-------------|
| 1   | G      | Gate        |
| 2   | S      | Source      |
| 3   | D      | Drain       |

## ORDERING INFORMATION

| Part Number  | Package   | Part Marking |
|--------------|-----------|--------------|
| SPP2341S23RG | SOT-23-3L | 41YW         |

※ Week Code : A ~ Z ( 1 ~ 26 ) ; a ~ z ( 27 ~ 52 )

※ SPP2341S23RG : Tape Reel ; Pb – Free

## ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

| Parameter                                       | Symbol           | Typical | Unit |
|---|------------------|---------|------|
| Drain-Source Voltage                            | V <sub>DSS</sub> | -20     | V    |
| Gate –Source Voltage                            | V <sub>GSS</sub> | ±12     | V    |
| Continuous Drain Current(T <sub>J</sub> =150°C) | I <sub>D</sub>   | TA=25°C | -4.0 |
|   |                  | TA=70°C | -2.8 |
| Pulsed Drain Current                            | I <sub>DM</sub>  | -12     | A    |
| Continuous Source Current(Diode Conduction)     | I <sub>S</sub>   | -1.0    | A    |
| Power Dissipation                               | P <sub>D</sub>   | TA=25°C | 1.25 |
|   |                  | TA=70°C | 0.8  |
| Operating Junction Temperature                  | T <sub>J</sub>   | -55/150 | °C   |
| Storage Temperature Range                       | T <sub>STG</sub> | -55/150 | °C   |
| Thermal Resistance-Junction to Ambient          | R <sub>θJA</sub> | 140     | °C/W |

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## ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

| Parameter                       | Symbol               | Conditions   | Min.  | Typ   | Max.  | Unit |
|---------------------------------|----------------------|--|-------|-------|-------|------|
| <b>Static</b>                   |                      |  |       |       |       |      |
| Drain-Source Breakdown Voltage  | V <sub>(BR)DSS</sub> | V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA  | -20   |       |       | V    |
| Gate Threshold Voltage          | V <sub>GS(th)</sub>  | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA  | -0.35 |       | -0.9  |      |
| Gate Leakage Current            | I <sub>GSS</sub>     | V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V   |       |       | ±100  | nA   |
| Zero Gate Voltage Drain Current | I <sub>DSS</sub>     | V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V   |       |       | -1    | uA   |
|                                 |                      | V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V<br>T <sub>J</sub> =55°C   |       |       | -10   |      |
| On-State Drain Current          | I <sub>D(on)</sub>   | V <sub>DS</sub> ≤ -5V, V <sub>GS</sub> =-4.5V  | -6    |       |       | A    |
| Drain-Source On-Resistance      | R <sub>DSS(on)</sub> | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-3.3A  |       | 0.036 | 0.045 | Ω    |
|                                 |                      | V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2.8A  |       | 0.045 | 0.055 |      |
|                                 |                      | V <sub>GS</sub> =-1.8V, I <sub>D</sub> =-2.3A  |       | 0.055 | 0.065 |      |
| Forward Transconductance        | g <sub>fs</sub>      | V <sub>DS</sub> =-5.0V, I <sub>D</sub> =-3.3A  |       | 3     |       | S    |
| Diode Forward Voltage           | V <sub>SD</sub>      | I <sub>S</sub> =-1.6A, V <sub>GS</sub> =0V   |       | -0.8  | -1.2  | V    |
| <b>Dynamic</b>                  |                      |  |       |       |       |      |
| Total Gate Charge               | Q <sub>g</sub>       | V <sub>DS</sub> =-6V, V <sub>GS</sub> =-4.5V<br>I <sub>D</sub> =-3.3A  |       | 8     | 13    | nC   |
| Gate-Source Charge              | Q <sub>gs</sub>      |  |       | 1.2   |       |      |
| Gate-Drain Charge               | Q <sub>gd</sub>      |  |       | 2.2   |       |      |
| Input Capacitance               | C <sub>iss</sub>     | V <sub>DS</sub> =-6V, V <sub>GS</sub> =0V<br>f=1MHz  |       | 700   |       | pF   |
| Output Capacitance              | C <sub>oss</sub>     |  |       | 160   |       |      |
| Reverse Transfer Capacitance    | C <sub>rss</sub>     |  |       | 120   |       |      |
| Turn-On Time                    | t <sub>d(on)</sub>   | V <sub>DD</sub> =-6V, R <sub>L</sub> =6Ω<br>I <sub>D</sub> =-1.0A, V <sub>GEN</sub> =-4.5V<br>R <sub>G</sub> =6Ω |       | 15    | 25    | ns   |
|                                 | t <sub>r</sub>       |  |       | 35    | 55    |      |
| Turn-Off Time                   | t <sub>d(off)</sub>  |  |       | 60    | 90    |      |
|                                 | t <sub>f</sub>       |  |       | 40    | 60    |      |